

LINESCAN HYPERSPPECTRAL IMAGE SENSOR

Imec's linescan image sensors offer unrivaled cost versus performance implementation of hyperspectral imaging technology. Our solution integrates hyperspectral filters monolithically on top of the sensor at wafer-level, providing high-level performance with significant reduction in size and cost. Our standard off-the-shelf linescan imager product includes 100 spectral bands and is packaged in a ready-to-use format for easy integration into your final application.

HYPERSPPECTRAL TECHNOLOGY FOR REAL-WORLD APPLICATIONS

Hyperspectral cameras, compared to traditional cameras, divide the light spectrum in many small wavelength bands. Therefore, a hyperspectral camera captures the spectral fingerprint of an object, a unique spectral signature providing very detailed information about its exact material constitution.

Hyperspectral imaging improves considerably the identification and classification of objects and is today recognized as a key enabling technology for next-generation industrial inspection, medical diagnosis and security applications.

IMEC'S UNIQUE SPECTRAL TECHNOLOGY

Our current hyperspectral imagers are built on commercially available CMOS image sensor wafers, specifically designed for the machine vision market, namely the CMOSIS CMV2000.

KEY SPECIFICATIONS

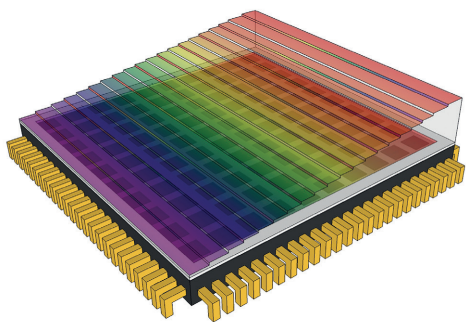
Wavelength range	600-1000nm (NIR) or 470-900nm (VNIR)
Number of spectral bands	100+ (NIR) or 150+ (VNIR)
Bandwidth per band (FWHM)	<10nm, collimated
Base imager type	CMOS imager, CMOSIS CMV2000 based
Resolution	2048x1088 pixels
Spatial pixels/lines	8 (NIR) or 6 (VNIR)
Spatial pixels/lines	2048
Scanned hyperspectral lines/second	2720 or limited by (camera) interface
Pixel pitch	5.5µm
Bit depth	8 or 10 bit

KEY BENEFITS

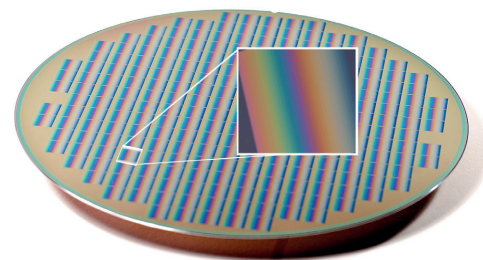
- **Extreme integration** of hyperspectral filters onto standard CMOS image sensors process: bulky collimator, prism and grating components are removed, no alignment issue
- **High performance & low-cost** hyperspectral solution supported by CMOS processing base and manufacturing infrastructure
- **Customizable design** to match filter band selection with your final application requirements

APPLICATIONS

- Optical sorting
- Spectroscopy
- Microscopy
- Counterfeit detection
- Skin health
- Agriculture
- Pharmaceutical
- Endoscopy
- Surveillance



Conceptual drawing of hyperspectral linescan imager with 100 static spectral filter structures



imec hyperspectral imager structures processed at wafer-level on top of commercial CMOS image sensor wafer

SENSOR FEATURES & INTERFACE

- Pipeline global shutter with true CDS
- 340 frames/s in 8 bit mode
- 180 frames/s in 10 bit mode
- Row windowing capable of up to 8 separate ROIs
- X-Y mirroring function
- 16 LVDS-outputs @ 480Mhz multiplexable to 8, 4 and 2 at reduced frame rate
- Multiple high dynamic range modes up to 90dB
- On-chip temperature sensor & timing generation
- SPI control
- Ceramic 95 pin PGA package (18,6mm x 18,6mm)

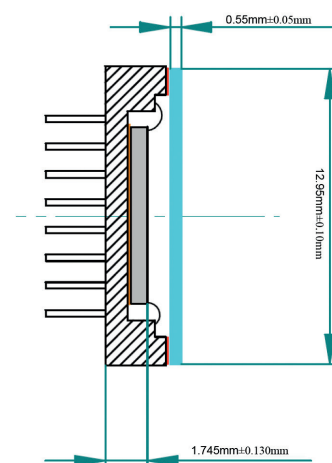
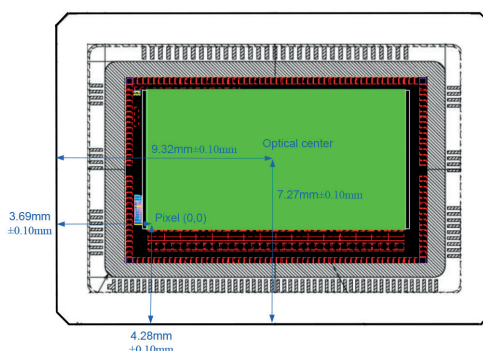
CUSTOMIZED TO FINAL APPLICATION

The current 'off-the-shelf' imager product available from imec scans 100-150+ spectral bands in the 600-1000nm or 450-960nm wavelength region. Custom linescan sensors can be provided based upon additional development.

This customization can be achieved by modifying the design of our filters over the CMOS sensor pixel array. Spectral filters can be tuned and designed for different numbers of bands, FWHM and different spectral ranges. By matching the spectral filters with the final application requirements, a custom hyperspectral imaging solution can be provided, optimized for size, cost and performance.

BASE IMAGER PERFORMANCE

Resolution	2048 x 1088
Pixel size	5.5µm x 5.5µm
Full well charge	13,5 Ke-
Conversion gain	0,075LSB/e- (10bit mode)
Sensitivity	4,64 V/lux.s
Temporal noise	13 e- (RMS)
Dynamic range	60dB
Optical format	2/3"
Parasitic light sensitivity	<1/50000
Dark current	125 LSB/s (@25°C)
Operating temperature	-30°C to +70°C
Power consumption	600mW
Fixed pattern noise	<1 LSB (<0,1% of full swing)



Hyperspectral imager package pin-out configuration

JEROME BARON

jerome.baron@imec.be
+32 16 28 32 82

DISCLAIMER - This information is provided 'AS IS', without any representation or warranty. Imec is a registered trademark for the activities of IMEC International (a legal entity set up under Belgian law as a "stichting van openbaar nut"), imec Belgium (IMEC vzw supported by the Flemish Government), imec the Netherlands (Stichting IMEC Nederland, part of Holst Centre which is supported by the Dutch Government), imec Taiwan (IMEC Taiwan Co.) and imec China (IMEC Microelectronics (Shanghai) Co. Ltd.) and imec India (Imec India Private Limited), imec Florida (IMEC USA nanoelectronics design center).